## General Description

The MAX15020 high-voltage step-down DC-DC converter operates over an input voltage range of 7.5 V to 40 V . The device integrates a $0.2 \Omega$ high-side switch and is capable of delivering 2 A load current with excellent load and line regulation. The output is dynamically adjustable from 0.5 V to 36 V through the use of an external reference input (REFIN). The MAX15020 consumes only $6 \mu \mathrm{~A}$ in shutdown mode.
The device utilizes feed-forward voltage-mode architecture for good noise immunity in the high-voltage switching environment and offers external compensation for maximum flexibility. The switching frequency is selectable to 300 kHz or 500 kHz and can be synchronized to an external clock signal of 100 kHz to 500 kHz by using the SYNC input. The IC features a maximum duty cycle of $95 \%$ (typ) at 300 kHz .
The device includes configurable undervoltage lockout (UVLO) and soft-start. Protection features include cycle-by-cycle current limit, hiccup-mode for output short-circuit protection, and thermal shutdown. The MAX15020 is available in a 20-pin TQFN $5 \mathrm{~mm} \times 5 \mathrm{~mm}$ package and is rated for operation over the $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature range

Applications
Printer Head Driver Power Supply
Automotive Power Supply
Industrial Power Supply
Step-Down Power Supply

- Wide 7.5V to 40V Input Voltage Range
- 2A Output Current, Up to 96\% Efficiency
- Dynamic Programmable Output Voltage (0.5V to 36V)
- Maximum Duty Cycle of 95\% (typ) at 300kHz
- 100kHz to 500 kHz Synchronizable SYNC Frequency Range
- Configurable UVLO and Soft-Start
- Low-Noise, Voltage-Mode Step-Down Converter
- Programmable Output-Voltage Slew Rate
- Lossless Constant Current Limit with Fixed Timeout to Hiccup Mode
- Extremely Low-Power Consumption (<6 A A typ) in Shutdown Mode
- 20-Pin (5mm x 5mm) Thin QFN Package

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
| :---: | :---: | :---: |
| MAX15020ATP + | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 20 TQFN-EP* |

+Denotes a lead(Pb)-free/RoHS-compliant package. *EP = Exposed pad.

Pin Configuration appears at end of data sheet.


For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

## ABSOLUTE MAXIMUM RATINGS

| IN, ON/OFF to GND.........................................-0.3V to +45V |  |
| :---: | :---: |
| LX to GND... | .-0.715V to (VIN + 0.3V) |
| BST to GND ............................................-0.3V to (VIN + 12V) |  |
| BST to LX........................................................-0.3V to +12V |  |
| PGND, EP to GND ...........................................-0.3V to +0.3V |  |
| REG, DVREG, SYNC to GND .............................-0.3V to +12V |  |
| FB, COMP, FSEL, REFIN, REFOUT, |  |
| SS to GND ................... | -0.3V to (VREG + 0.3V) |
| Continuous Current through Internal Power MOSFET |  |
| $\mathrm{T}_{J}=+125^{\circ} \mathrm{C}$. | 4A |
| $\mathrm{T}_{J}=+150^{\circ} \mathrm{C}$ | 2.7A |



Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

$\left(V_{I N}=36 \mathrm{~V}, \mathrm{~V}_{\text {REG }}=\mathrm{V}_{\text {DVREG }}, \mathrm{V}_{\text {PGND }}=\mathrm{V}_{G N D}=\mathrm{V}_{\text {EP }}=0 \mathrm{~V}, \mathrm{~V}_{\text {SYNC }}=0 \mathrm{~V}, \mathrm{C}_{\text {REFOUT }}=0.1 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}, \mathrm{FSEL}=\mathrm{REG}$, unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage Range | VIN |  | 7.5 |  | 40.0 | V |
| UVLO Rising Threshold | UVLORISING |  | 6.80 | 7.20 | 7.45 | V |
| UVLO Falling Threshold | UVLOFALLING |  | 6.0 | 6.5 | 7.0 | V |
| UVLO Hysteresis | UVLOHYST |  |  | 0.7 |  | V |
| Quiescent Supply Current |  | $\mathrm{V}_{I N}=40 \mathrm{~V}, \mathrm{~V}_{\mathrm{FB}}=1.3 \mathrm{~V}$ |  | 1.6 | 2.8 | mA |
| Switching Supply Current |  | $\mathrm{V}_{\text {IN }}=40 \mathrm{~V}, \mathrm{~V}_{\mathrm{FB}}=0 \mathrm{~V}$ |  | 14.5 |  | mA |
| Shutdown Current | ISHDN | $\mathrm{V}_{\text {ON/OFF }}=0.2 \mathrm{~V}, \mathrm{~V}$ IN $=40 \mathrm{~V}$ |  | 6 | 15 | $\mu \mathrm{A}$ |
| ON/OFF CONTROL |  |  |  |  |  |  |
| Input-Voltage Threshold | VON/OFF | Von/OFF rising | 1.200 | 1.225 | 1.270 | V |
| Input-Voltage Threshold Hysteresis |  |  |  | 120 |  | mV |
| Input Bias Current |  | $\mathrm{V}_{\mathrm{ON} / \mathrm{OFF}}=0 \mathrm{~V}$ to V IN | -250 |  | +250 | nA |
| Shutdown Threshold Voltage | VSD |  |  |  | 0.2 | V |
| INTERNAL VOLTAGE REGULATOR (REG) |  |  |  |  |  |  |
| Output Voltage |  | IREG $=0$ to 20 mA | 7.1 |  | 8.3 | V |
| OSCILLATOR |  |  |  |  |  |  |
| Frequency | fsw | $\mathrm{V}_{\text {FSEL }}=0 \mathrm{~V}$ | 450 |  | 550 | kHz |
|  |  | $V_{\text {FSEL }}=V_{\text {REG }}$ | 270 |  | 330 |  |
| Maximum Duty Cycle | Dmax | $V_{\text {FSEL }}=0 \mathrm{~V}$ | 85 |  |  | \% |
|  |  | $\mathrm{V}_{\text {FSEL }}=\mathrm{V}_{\text {REG }}$ | 90 |  |  |  |
| SYNC/FSEL High-Level Voltage |  |  | 2 |  |  | V |
| SYNC/FSEL Low-Level Voltage |  |  |  |  | 0.8 | V |
| SYNC Frequency Range | fsync | $\mathrm{V}_{\text {FSEL }}=\mathrm{V}_{\text {REG }}$ | 100 |  | 550 | kHz |

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

## ELECTRICAL CHARACTERISTICS (continued)

$\left(V_{I N}=36 \mathrm{~V}, \mathrm{~V}_{\text {REG }}=\mathrm{V}_{\text {DVREG }}, V_{\text {PGND }}=\mathrm{V}_{\text {GND }}=\mathrm{V}_{\mathrm{EP}}=0 \mathrm{~V}, \mathrm{~V}_{\text {SYNC }}=0 \mathrm{~V}, \mathrm{C}_{\text {REFOUT }}=0.1 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}\right.$ to $+125^{\circ} \mathrm{C}, \mathrm{FSEL}=\mathrm{REG}$, unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)


Note 1: Limits are $100 \%$ production tested at $T_{A}=T_{J}=+25^{\circ} \mathrm{C}$. Limits at $-40^{\circ} \mathrm{C}$ and $+125^{\circ} \mathrm{C}$ are guaranteed by design.

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

$\left(\mathrm{V} I \mathrm{~N}=36 \mathrm{~V}\right.$, Circuit of Figure $2, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted. $)$


Typical Operating Characteristics

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

Typical Operating Characteristics (continued)
$\left(\mathrm{V}_{\mathrm{IN}}=36 \mathrm{~V}\right.$, Circuit of Figure 2, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)




EFFICIENCY vs. LOAD CURRENT


## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

Typical Operating Characteristics (continued)
$\left(\mathrm{V}_{\mathrm{IN}}=36 \mathrm{~V}\right.$, Circuit of Figure 2, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


HEAVY-LOAD SWITCHING WAVEFORMS

$1 \mu s / d i v$


FEEDBACK VOLTAGE vs. REFIN INPUT VOLTAGE


## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

Typical Operating Characteristics (continued)
(VIN $=36 \mathrm{~V}$, Circuit of Figure 2, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)




SOFT-START CHARGE CURRENT
vs. TEMPERATURE


## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

Pin Description

| PIN | NAME | FUNCTION |
| :---: | :---: | :---: |
| 1 | COMP | Voltage-Error-Amplifier Output. Connect COMP to the necessary compensation feedback network. |
| 2 | FB | Feedback Regulation Point. Connect to the center tap of an external resistor-divider connected between the output and GND to set the output voltage. The FB voltage regulates to the voltage applied to REFIN. |
| 3 | ON/OFF | ON/OFF Control. The ON/OFF rising threshold is set to approximately 1.225 V . Connect to the center tap of a resistive divider connected between $I N$ and GND to set the turn-on (rising) threshold. Connect ON/OFF to GND to shut down the IC. Connect $\mathrm{ON} / \overline{\mathrm{OFF}}$ to $\mathbb{I N}$ for always-on operation given that $\mathrm{V}_{\mathbb{N}}$ has risen above the UVLO threshold. ON/OFF can be used for power-supply sequencing. |
| 4 | REFOUT | 0.98 V Reference Voltage Output. Bypass REFOUT to GND with a 0.1 FF ceramic capacitor. REFOUT is to be used only with REFIN. It is not to be used to power any other external circuitry. |
| 5 | SS | Soft-Start. Connect a 0.01 FF or greater ceramic capacitor from SS to GND. See the Soft-Start (SS) section. |
| 6 | REFIN | External Reference Input. Connect to an external reference. $V_{F B}$ regulates to the voltage applied to REFIN. Connect REFIN to REFOUT to use the internal 1V reference. See the Reference Input and Output (REFIN, REFOUT) section. |
| 7 | FSEL | Internal Switching Frequency Selection Input. Connect FSEL to REG to select fsw = 300kHz. Connect FSEL to GND to select fsw $=500 \mathrm{kHz}$. When an external clock is connected to SYNC connect FSEL to REG. |
| 8 | SYNC | Oscillator Synchronization Input. SYNC can be driven by an external 100 kHz to 500 kHz clock to synchronize the MAX15020's switching frequency. Connect SYNC to GND to disable the synchronization function. When using SYNC, connect FSEL to REG. |
| 9 | DVREG | Power Supply for Internal Digital Circuitry. Connect a $10 \Omega$ resistor from REG to DVREG. Connect DVREG to the anode of the boost diode, D2 in Figure 2. Bypass DVREG to GND with at least a $1 \mu \mathrm{~F}$ ceramic capacitor. |
| 10 | PGND | Power-Ground Connection. Connect the input filter capacitor's negative terminal, the anode of the freewheeling diode, and the output filter capacitor's return to PGND. Connect externally to GND at a single point near the input bypass capacitor's return terminal. |
| 11 | N.C. | No Connection. Leave unconnected or connect to GND |
| 12 | BST | High-Side Gate Driver Supply. Connect BST to the cathode of the boost diode and to the positive terminal of the boost capacitor. |
| 13, 14, 15 | LX | Source Connection of Internal High-Side Switch. Connect the inductor and rectifier diode's cathode to LX. |
| 16, 17, 18 | IN | Supply Input Connection. Connect to an external voltage source from 7.5 V to 40 V . |
| 19 | REG | 8 Internal Regulator Output. Bypass to GND with at least a $1 \mu$ F ceramic capacitor. Do not use REG to power external circuitry. |
| 20 | GND | Ground Connection. Solder the exposed pad to a large GND plane. Connect GND and PGND together at one point near the input bypass capacitor return terminal. |
| - | EP | Exposed Pad. Connect EP to GND. Connecting EP does not remove the requirement for proper ground connections to the appropriate pins. See the PCB Layout and Routing section. |

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming



Figure 1. Functional Diagram

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming



Figure 2. Typical Application Circuit

## Detailed Description

The MAX15020 voltage-mode step-down converter contains an internal $0.2 \Omega$ power MOSFET switch. The MAX15020 input voltage range is 7.5 V to 40 V . The internal low $\operatorname{RDS}(\mathrm{ON})$ switch allows for up to 2A of output current. The external compensation, voltage feedforward, and automatically adjustable maximum ramp amplitude simplify the loop compensation design allowing for a variety of L and C filter components. In shutdown, the supply current is typically $6 \mu \mathrm{~A}$. The output voltage is dynamically adjustable from 0.5 V to 36 V . Additional features include an externally programmable UVLO through the ON/OFF pin, a programmable softstart, cycle-by-cycle current limit, hiccup-mode output short-circuit protection, and thermal shutdown.

## Internal Linear Regulator (REG)

REG is the output terminal of the 8 V LDO powered from IN and provides power to the IC. Connect REG externally to DVREG to provide power for the internal digital circuitry. Place a $1 \mu \mathrm{~F}$ ceramic bypass capacitor, C2, next to the IC from REG to GND. During normal opera-
tion, REG is intended for powering up only the internal circuitry and should not be used to supply power to the external loads.

## UVLO/ON/ $\overline{\text { OFF }}$ Threshold

The MAX15020 provides a fixed 7V UVLO function which monitors the input voltage (VIN). The device is held off until VIN rises above the UVLO threshold.
ON/OFF provides additional turn-on/turn-off control. Program the ON/OFF threshold by connecting a resistive divider from $I N$ to ON/OFF to GND. The device turns on when Von/OFF rises above the ON/OFF threshold ( 1.225 V ), given that $\mathrm{VIN}_{\mathrm{I}}$ has risen above the UVLO threshold.
Driving ON/OFF to ground places the IC in shutdown. When in shutdown the internal power MOSFET turns off, all internal circuitry shuts down, and the quiescent supply current reduces to $6 \mu \mathrm{~A}$ (typ.). Connect an RC network from ON/OFF to GND to set a turn-on delay that can be used to sequence the output voltages of multiple devices.

# 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming 

Soft-Start (SS)
At startup, after VIN is applied and the UVLO threshold is reached, a $15 \mu \mathrm{~A}$ (typ) current is sourced into the capacitor (Css) connected from SS to GND forcing the VSS voltage to ramp up slowly. If VREFIN is set to a DC voltage or has risen faster than the CSS charge rate, then VSS will stop rising once it reaches VREFIN. If Vrefin rises at a slower rate, VSs will follow the Vrefin voltage rise rate. Vout rises at the same rate as VSS since VFB follows VSS.
Set the soft-start time (tss) using following equation:

$$
t_{S S}=\frac{V_{\text {REFIN }} \times C_{S S}}{15 \mu \mathrm{~A}}
$$

where tss is in seconds and Css is in Farads.

## Reference Input and <br> Output (REFIN, REFOUT)

The MAX15020 features a reference input for the internal error amplifier. The IC regulates FB to the SS voltage which is driven by the DC voltage applied to REFIN. Connect REFIN to REFOUT to use the internal 0.98 V reference. Connect REFIN to a variable DC voltage source to dynamically control the output voltage. Alternatively, REFIN can also be driven by a duty-cycle control PWM source through a lowpass RC filter (Figure 2).

## Internal Digital Power Supply (DVREG)

 DVREG is the supply input for the internal digital power supply. The power for DVREG is derived from the output of the internal regulator (REG). Connect a $10 \Omega$ resistor from REG to DVREG. Bypass DVREG to GND with at least a $1 \mu \mathrm{~F}$ ceramic capacitor.
## Error Amplifier

The output of the internal error amplifier (COMP) is available for frequency compensation (see the Compensation Design section). The inverting input is FB, the noninverting input is SS, and the output is COMP. The error amplifier has an 80 dB open-loop gain and a 1.8 MHz GBW product. When an external clock is used, connect FSEL to REG.

## Oscillator/Synchronization Input (SYNC)

With SYNC connected to GND, the IC uses the internal oscillator and switches at a fixed frequency of 300 kHz or

500 kHz based upon the selection of FSEL. For external synchronization, drive SYNC with an external clock from 100 kHz to 500 kHz and connect FSEL to REG. When driven with an external clock, the device synchronizes to the rising edge of SYNC.

PWM Comparator/Voltage Feed-Forward An internal ramp generator is compared against the output of the error amplifier to generate the PWM signal. The maximum amplitude of the ramp (VRAMP) automatically adjusts to compensate for input voltage and oscillator frequency changes. This causes the VIN / VRAMP to be a constant 9V/V across the input voltage range of 7.5 V to 40 V and the SYNC frequency range of 100 kHz to 500 kHz . This simplifies loop compensation design by allowing large input voltage ranges and large frequency range selection.

## Output Short-Circuit Protection (Hiccup Mode)

The MAX15020 protects against an output short circuit by utilizing hiccup-mode protection. In hiccup mode, a series of sequential cycle-by-cycle current-limit events cause the part to shut down and restart with a soft-start sequence. This allows the device to operate with a continuous output short circuit.
During normal operation, the switch current is measured cycle-by-cycle. When the current limit is exceeded, the internal power MOSFET turns off until the next on-cycle and the hiccup counter increments. If the counter counts four consecutive overcurrent limit events, the device discharges the soft-start capacitor and shuts down for 512 clock periods before restarting with a softstart sequence. Each time the power MOSFET turns on and the device does not exceed the current limit, the counter is reset.

Thermal-Overload Protection
The MAX15020 features an integrated thermal-overload protection. Thermal-overload protection limits the total power dissipation in the device and protects it in the event of an extended thermal fault condition. When the die temperature exceeds $+160^{\circ} \mathrm{C}$, an internal thermal sensor shuts down the part, turning off the power MOSFET and allowing the IC to cool. After the temperature falls by $20^{\circ} \mathrm{C}$, the part restarts beginning with the soft-start sequence.

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

## Applications Information

## Setting the ON/OFF Threshold

When the voltage at ON/OFF rises above 1.225 V , the MAX15020 turns on. Connect a resistive divider from IN to ON/OFF to GND to set the turn-on voltage (see Figure 2). First select the ON/OFF to the GND resistor (R2), then calculate the resistor from IN to ON/OFF (R1) using the following equation:

$$
\mathrm{R} 1=\mathrm{R} 2 \times\left[\frac{\mathrm{V}_{\mathrm{IN}}}{\mathrm{~V}_{\mathrm{ON} / \overline{\mathrm{OFF}}}}-1\right]
$$

where $\mathrm{V}_{\mathrm{I}}$ is the input voltage at which the converter turns on, V ON/OFF $=1.225 \mathrm{~V}$ and R 2 is chosen to be less than $600 \mathrm{k} \Omega$.
If ON/OFF is connected to IN directly, the UVLO feature monitors the supply voltage at IN and allows operation to start when VIN rises above 7.2V.

## Setting the Output Voltage

Connect a resistor-divider from OUT to FB to GND to set the output voltage (see Figure 2). First calculate the resistor (R7) from OUT to FB using the guidelines in the Compensation Design section. Once R7 is known, calculate R8 using the following equation:

$$
\mathrm{R} 8=\frac{\mathrm{R} 7}{\left[\frac{\mathrm{~V}_{\mathrm{OUT}}}{\mathrm{~V}_{\mathrm{FB}}}-1\right]}
$$

where $\mathrm{V}_{\mathrm{FB}}=$ REFIN and REFIN $=0$ to 3.6 V .
Setting the Output-Voltage Slew Rate The output-voltage rising slew rate tracks the Vss slew rate, given that the control loop is relatively fast compared with the VSS slew rate. The maximum VSS upswing slew rate is controlled by the soft-start current charging the capacitor connected from SS to GND according to the formula below:

$$
\frac{d V_{O U T}}{d t}=\frac{R_{7}+R_{8}}{R_{8}} \times \frac{d V_{S S}}{d t}=\frac{R_{7}+R_{8}}{R_{8}} \frac{I_{S S}}{C_{S S}}
$$

when driving VSS with a slow-rising voltage source at REFIN, Vout will slowly rise according to the Vrefin slew rate.

The output-voltage falling slew rate is limited to the discharge rate of Css assuming there is enough load current to discharge the output capacitor at this rate. The Css discharge current is $15 \mu \mathrm{~A}$. If there is no load, then the output voltage falls at a slower rate based upon leakage and additional current drain from Cout.

## Inductor Selection

Three key inductor parameters must be specified for operation with the MAX15020: inductance value (L), peak inductor current (IPEAK), and inductor saturation current (ISAT). The minimum required inductance is a function of operating frequency, input-to-output voltage differential, and the peak-to-peak inductor current ( $\Delta \mathrm{L} \mathrm{L}$ ). Higher $\Delta \mathrm{I} \mathrm{L}$ allows for a lower inductor value while a lower $\Delta I L$ requires a higher inductor value. A lower inductor value minimizes size and cost and improves large-signal and transient response, but reduces efficiency due to higher peak currents and higher peak-topeak output voltage ripple for the same output capacitor. Higher inductance increases efficiency by reducing the ripple current. Resistive losses due to extra wire turns can exceed the benefit gained from lower ripple current levels especially when the inductance is increased without also allowing for larger inductor dimensions. A good compromise is to choose $\Delta l$ P-p equal to $40 \%$ of the full load current.
Calculate the inductor using the following equation:

$$
L=\frac{\left(V_{I N}-V_{\text {OUT }}\right) \times V_{\text {OUT }}}{V_{I N} \times f_{S W} \times \Delta I_{L}}
$$

VIN and Vout are typical values so that efficiency is optimum for typical conditions. The switching frequency (fsw) is fixed at 300 kHz or 500 kHz and can vary between 100 kHz and 500 kHz when synchronized to an external clock (see the Oscillator/Synchronization Input (SYNC) section). The peak-to-peak inductor current, which reflects the peak-to-peak output ripple, is worst at the maximum input voltage. See the Output Capacitor Selection section to verify that the worst-case output ripple is acceptable. The inductor saturating current (ISAT) is also important to avoid runaway current during continuous output short circuit. Select an inductor with an ISAT specification higher than the maximum peak current limit of 4.5 A .

# 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming 

## Input Capacitor Selection

The discontinuous input current of the buck converter causes large input ripple currents and therefore the input capacitor must be carefully chosen to keep the input-voltage ripple within design requirements. The input-voltage ripple is comprised of $\Delta \mathrm{V}_{\mathrm{Q}}$ (caused by the capacitor discharge) and $\Delta$ VESR (caused by the ESR (equivalent series resistance) of the input capacitor). The total voltage ripple is the sum of $\Delta \mathrm{V}_{\mathrm{Q}}$ and $\Delta \mathrm{V}_{\mathrm{ESR}}$. Calculate the input capacitance and ESR required for a specified ripple using the following equations:

$$
\begin{aligned}
& E S R=\frac{\Delta V_{E S R}}{\left(\mathrm{I}_{\mathrm{OUT}} / \mathrm{MAX}+\frac{\Delta \mathrm{I}_{\mathrm{L}}}{2}\right)} \\
& \mathrm{C}_{\mathrm{IN}}=\frac{\mathrm{I}_{\text {OUT_MAX }} \times \mathrm{D}(1-\mathrm{D})}{\Delta \mathrm{V}_{\mathrm{Q}} \times \mathrm{f}_{\mathrm{SW}}}
\end{aligned}
$$

where:

$$
\begin{aligned}
& \Delta I_{L}=\frac{\left(V_{I N}-V_{\text {OUT }}\right) \times V_{\text {OUT }}}{V_{I N} \times f_{S W} \times L} \\
& D=\frac{V_{\text {OUT }}}{V_{\text {IN }}}
\end{aligned}
$$

IOUT_MAX is the maximum output current, $D$ is the duty cycle, and fSW is the switching frequency.
The MAX15020 includes internal and external UVLO hysteresis and soft-start to avoid possible unintentional chattering during turn-on. However, use a bulk capacitor if the input source impedance is high. Use enough input capacitance at lower input voltages to avoid possible undershoot below the UVLO threshold during transient loading.

## Output Capacitor Selection

The allowable output-voltage ripple and the maximum deviation of the output voltage during load steps determine the output capacitance and its ESR. The output ripple is mainly composed of $\Delta \mathrm{V}_{\mathrm{Q}}$ (caused by the capacitor discharge) and $\Delta \mathrm{V}$ ESR (caused by the voltage drop across the ESR of the output capacitor). The equations for calculating the peak-to-peak output voltage ripple are:

$$
\begin{aligned}
& \Delta V_{\mathrm{Q}}=\frac{\Delta l_{\mathrm{L}}}{16 \times \mathrm{C}_{\mathrm{OUT}} \times \mathrm{f}_{\mathrm{SW}}} \\
& \Delta \mathrm{~V}_{\mathrm{ESR}}=\mathrm{ESR} \times \Delta \mathrm{l}_{\mathrm{L}}
\end{aligned}
$$

Normally, a good approximation of the output-voltage ripple is $\Delta \mathrm{V}_{\mathrm{RIPPLE}} \approx \Delta \mathrm{V}_{\mathrm{ESR}}+\Delta \mathrm{V}_{\mathrm{Q}}$. If using ceramic capacitors, assume the contribution to the output-voltage ripple from ESR and the capacitor discharge to be equal to $20 \%$ and $80 \%$, respectively. $\Delta \mathrm{I}_{\mathrm{L}}$ is the peak-topeak inductor current (see the Input Capacitor Selection section) and fSW is the converter's switching frequency.
The allowable deviation of the output voltage during fast load transients also determines the output capacitance, its ESR, and its equivalent series inductance (ESL). The output capacitor supplies the load current during a load step until the controller responds with a greater duty cycle. The response time (tRESPONSE) depends on the closed-loop bandwidth of the converter (see the Compensation Design section). The resistive drop across the output capacitor's ESR, the drop across the capacitor's ESL ( $\Delta \mathrm{V}$ ESL) , and the capacitor discharge cause a voltage droop during the load step. Use a combination of low-ESR tantalum/aluminum electrolytic and ceramic capacitors for better transient load and voltage ripple performance. Surface-mount capacitors and capacitors in parallel help reduce the ESL. Keep the maximum output-voltage deviations below the tolerable limits of the electronics powered. Use the following equations to calculate the required ESR, ESL, and capacitance value during a load step:

$$
\begin{aligned}
& \text { ESR }=\frac{V_{\text {ESR }}}{I_{\text {STEP }}} \\
& C_{\text {OUT }}=\frac{I_{\text {STEP }} \times t_{\text {RESPONSE }}}{\Delta V_{Q}} \\
& \text { ESL }=\frac{\Delta V_{\text {ESL }} \times t_{\text {STEP }}}{I_{\text {STEP }}}
\end{aligned}
$$

where ISTEP is the load step, tSTEP is the rise time of the load step, and tRESPONSE is the response time of the controller.

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

## Compensation Design

The MAX15020 uses a voltage-mode control scheme that regulates the output voltage by comparing the error-amplifier output (COMP) with an internal ramp to produce the required duty cycle. The output Iowpass LC filter creates a double pole at the resonant frequency, which has a gain drop of $-40 \mathrm{~dB} / \mathrm{decade}$. The error amplifier must compensate for this gain drop and phase shift to achieve a stable closed-loop system.
The basic regulator loop consists of a power modulator, an output feedback divider, and a voltage error amplifier. The power modulator has a DC gain set by VIN / VRAMP, with a double pole and a single zero set by the output inductance (L), the output capacitance (COUT) (C6 in the Figure 2) and its ESR. The power modulator incorporates a voltage feed-forward feature, which automatically adjusts for variations in the input voltage resulting in a DC gain of 9 . The following equations define the power modulator:

$$
\begin{aligned}
& \mathrm{G}_{\mathrm{MOD}(\mathrm{DC})}=\frac{\mathrm{V}_{\mathrm{IN}}}{\mathrm{~V}_{\mathrm{RAMP}}}=9 \\
& \mathrm{f}_{\mathrm{LC}}=\frac{1}{2 \pi \sqrt{\mathrm{~L} \mathrm{\times C}}} \\
& \mathrm{f}_{\mathrm{ESR}}=\frac{1}{2 \pi \times \mathrm{C}_{\text {OUT }} \times \mathrm{ESR}}
\end{aligned}
$$

The switching frequency is internally set at 300 kHz or 500 kHz , or can vary from 100 kHz to 500 kHz when driven with an external SYNC signal. The crossover frequency (fc), which is the frequency when the closed-loop gain is equal to unity, should be set as fSW / $2 \pi$ or lower.
The error amplifier must provide a gain and phase bump to compensate for the rapid gain and phase loss from the LC double pole. This is accomplished by utilizing a Type 3 compensator that introduces two zeros and three poles into the control loop. The error amplifier has a low-frequency pole (fp1) near the origin.
In reference to Figures 3 and 4, the two zeros are at:

$$
f_{Z 1}=\frac{1}{2 \pi \times R 9 \times C 12} \text { and } f_{Z 2}=\frac{1}{2 \pi \times(R 6+R 7) \times C 11}
$$

And the higher frequency poles are at:

$$
\mathrm{f}_{\mathrm{P} 2}=\frac{1}{2 \pi \times \mathrm{R} 6 \times \mathrm{C} 11} \text { and } \mathrm{f}_{\mathrm{P} 3}=\frac{1}{2 \pi \times \mathrm{R} 9 \times\left(\frac{\mathrm{C} 12 \times \mathrm{C} 13}{\mathrm{C} 12+\mathrm{C} 13}\right)}
$$

Compensation When $f_{C}<f_{E S R}$
Figure 3 shows the error-amplifier feedback as well as its gain response for circuits that use low-ESR output capacitors (ceramic). In this case fZESR occurs after fc.
fZ 1 is set to $0.8 \times \mathrm{fLC}(\mathrm{MOD})$ and $\mathrm{fZ2}$ is set to fLC to compensate for the gain and phase loss due to the double pole. Choose the inductor (L) and output capacitor (Cout) as described in the Inductor Selection and Output Capacitor Selection sections.
Choose a value for the feedback resistor R9 in Figure 3 (values between $1 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega$ are adequate).
C12 is then calculated as:

$$
\mathrm{C} 12=\frac{1}{2 \pi \times 0.8 \times \mathrm{f}_{\mathrm{LC}} \times \mathrm{R9}}
$$

$\mathrm{f}_{\mathrm{C}}$ occurs between f Z2 and $\mathrm{f}_{\mathrm{P} 2}$. The error-amplifier gain (GEA) at $\mathrm{f}_{\mathrm{C}}$ is due primarily to C11 and R9.
Therefore, $\left.\mathrm{GEA}_{\mathrm{E}} \mathrm{fC}\right)=2 \pi \times \mathrm{ff}_{\mathrm{C}} \times \mathrm{C} 11 \times \mathrm{R9}$ and the modulator gain at $\mathrm{f}_{\mathrm{C}}$ is:

$$
\mathrm{G}_{\mathrm{MOD}(\mathrm{fC})}=\frac{\mathrm{G}_{\mathrm{MOD}(\mathrm{DC})}}{(2 \pi)^{2} \times \mathrm{L} \times \mathrm{C}_{\mathrm{OUT}} \times \mathrm{f}_{\mathrm{C}}{ }^{2}}
$$

Since $G_{E A(f C)} \times G_{M O D(f C)}=1, C 11$ is calculated by:

$$
\mathrm{C} 11=\frac{\mathrm{f}_{\mathrm{C}} \times \mathrm{L} \times \mathrm{C}_{\mathrm{OUT}} \times 2 \pi}{\mathrm{R} 9 \times \mathrm{G}_{\mathrm{MOD}(\mathrm{DC})}}
$$

fP 2 is set at $1 / 2$ the switching frequency ( $f s w$ ). R6 is then calculated by:

$$
\mathrm{R} 6=\frac{1}{2 \pi \times \mathrm{C} 11 \times 0.5 \times \mathrm{f}_{\mathrm{SW}}}
$$

Since R7 >> R6, R7 + R6 can be approximated as R7. $R 7$ is then calculated as:

$$
\mathrm{R} 7=\frac{1}{2 \pi \times \mathrm{f}_{\mathrm{LC}} \times \mathrm{C} 11}
$$

$\mathrm{ff}_{\mathrm{f}}$ is set at $5 \times \mathrm{f} \mathrm{C}$. Therefore, C 13 is calculated as:

$$
\mathrm{C} 13=\frac{\mathrm{C} 12}{2 \pi \times \mathrm{C} 12 \times \mathrm{R9} \times \mathrm{f}_{\mathrm{P} 3}-1}
$$

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming



Figure 3. Error-Amplifier Compensation Circuit (Closed-Loop and Error-Amplifier Gain Plot) for Ceramic Capacitors

## Compensation when $f_{C}>f_{\text {ZESR }}$

For larger ESR capacitors such as tantalum and aluminum electrolytics, $\mathrm{f}_{\mathrm{ZESR}}$ can occur before $\mathrm{f} C$. If $\mathrm{f} Z E S R$ $<\mathrm{f}_{\mathrm{C}}$, then $\mathrm{f}_{\mathrm{C}}$ occurs between $\mathrm{fp}_{2}$ and $\mathrm{fP}_{3}$. $\mathrm{fZ}_{\mathrm{Z}}$ and fZ 2 remain the same as before, however, fp2 is now set equal to fZESR. The output capacitor's ESR zero frequency is higher than flC but lower than the closedloop crossover frequency. The equations that define the error amplifier's poles and zeros (fZ1, fZ2, fp1, fp2, and fP 3 ) are the same as before. However, fp 2 is now lower than the closed-loop crossover frequency. Figure 4 shows the error-amplifier feedback as well as its gain response for circuits that use higher-ESR output capacitors (tantalum or aluminum electrolytic).
Pick a value for the feedback resistor R9 in Figure 4 (values between $1 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega$ are adequate).
C12 is then calculated as:

$$
\mathrm{C} 12=\frac{1}{2 \pi \times 0.8 \times f_{\mathrm{LC}} \times \mathrm{R9}}
$$

The error-amplifier gain between $\mathrm{fp}_{2}$ and $\mathrm{fp}_{2}$ is approximately equal to R9 / R6 (given that R6 << R7). R6 can then be calculated as:



Figure 4. Error-Amplifier Compensation Circuit (Closed-Loop and Error-Amplifier Gain Plot) for Higher ESR Output Capacitors

$$
R 6=\frac{R 9 \times 10 \times f_{L C}{ }^{2}}{f_{C}{ }^{2}}
$$

C11 is then calculated as:

$$
\mathrm{C} 11=\frac{\mathrm{C}_{\mathrm{OUT}} \times \mathrm{ESR}}{\mathrm{R} 6}
$$

Since R7 >> R6, R7 + R6 can be approximated as R7. $R 7$ is then calculated as:

$$
\mathrm{R} 7=\frac{1}{2 \pi \times \mathrm{f}_{\mathrm{LC}} \times \mathrm{C} 11}
$$

$\mathrm{ff}_{\mathrm{P}}$ is set at $5 \times \mathrm{fc}$. Therefore, C 13 is calculated as:

$$
\mathrm{C} 13=\frac{\mathrm{C} 12}{2 \pi \times \mathrm{C} 12 \times \mathrm{R} 9 \times \mathrm{fP}_{\mathrm{P}}-1}
$$

Based on the calculations above, the following compensation values are recommended when the switching frequency of DC-DC converter ranges from 100 kHz to 500 kHz . (Note: The compensation parameters in Figure 2 are strongly recommended if the switching frequency is from 300 kHz to 500 kHz .)

# 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming 

## Power Dissipation

The MAX15020 is available in a thermally enhanced package and can dissipate up to 2.7 W at $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$. When the die temperature reaches $+160^{\circ} \mathrm{C}$, the part shuts down and is allowed to cool. After the parts cool by $20^{\circ} \mathrm{C}$, the device restarts with a soft-start.
The power dissipated in the device is the sum of the power dissipated from supply current ( PQ ), transition losses due to switching the internal power MOSFET (PSw), and the power dissipated due to the RMS current through the internal power MOSFET (PMOSFET). The total power dissipated in the package must be limited such that the junction temperature does not exceed its absolute maximum rating of $+150^{\circ} \mathrm{C}$ at maximum ambient temperature. Calculate the power lost in the MAX15020 using the following equations:
The power loss through the switch:

$$
\begin{aligned}
& \text { PMOSFET }=I_{\text {RMS_MOSFET }}{ }^{2} \times \text { R }_{\text {ON }} \\
& I_{\text {RMS_MOSFET }}=\sqrt{\left[L^{2} \mathrm{PK}_{+}+\left(\mathrm{I}_{\mathrm{PK}+} \times \mathrm{I}_{\mathrm{PK}}\right)+\mathrm{I}_{\mathrm{PK}}\right] \times \frac{\mathrm{D}}{3}} \\
& I_{\text {PK }+}=I_{\text {OUT }}+\frac{\Delta I_{L}}{2} \\
& I_{\text {PK- }}=I_{\text {OUT }}-\frac{\Delta I_{L}}{2}
\end{aligned}
$$

RON is the on-resistance of the internal power MOSFET (see the Electrical Characteristics table).
The power loss due to switching the internal MOSFET:

$$
P_{\text {SW }}=\frac{V_{\text {IN }} \times I_{\text {OUT }} \times\left(t_{R} \times t_{F}\right) \times f_{\text {SW }}}{4}
$$

where $t_{R}$ and $t F$ are the rise and fall times of the internal power MOSFET measured at LX.

The power loss due to the switching supply current (Isw):

$$
P Q=V_{I N} \times I S W
$$

The total power dissipated in the device is:

$$
\text { PTOTAL }=\text { PMOSFET + PSW + PQ }
$$

## PCB Layout and Routing

Use the following guidelines to layout the switching voltage regulator:

1) Place the IN and DVREG bypass capacitors close to the MAX15020 PGND pin. Place the REG bypass capacitor close to the GND pin.
2) Minimize the area and length of the high-current loops from the input capacitor, switching MOSFET, inductor, and output capacitor back to the input capacitor negative terminal.
3) Keep short the current loop formed by the switching MOSFET, Schottky diode, and input capacitor.
4) Keep GND and PGND isolated and connect them at one single point close to the negative terminal of the input filter capacitor.
5) Place the bank of output capacitors close to the load.
6) Distribute the power components evenly across the board for proper heat dissipation.
7) Provide enough copper area at and around the MAX15020 and the inductor to aid in thermal dissipation.
8) Use $20 z$ copper to keep the trace inductance and resistance to a minimum. Thin copper PCBs can compromise efficiency since high currents are involved in the application. Also, thicker copper conducts heat more effectively, thereby reducing thermal impedance.
9) Place enough vias in the pad for the EP of the MAX15020 so that the heat generated inside can be effectively dissipated by PCB copper.

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

Pin Configuration


Chip Information
PROCESS: BICMOS

## Package Information

For the latest package outline information and land patterns (footprints), go to www.maxim-ic.com/packages. Note that a "+", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE <br> TYPE | PACKAGE <br> CODE | OUTLINE <br> NO. | LAND <br> PATTERN NO. |
| :---: | :---: | :---: | :---: |
| 20 TQFN-EP | $\mathrm{T} 2055+5$ | $\underline{\mathbf{2 1 - 0 1 4 0}}$ | $\underline{\mathbf{9 0}-0010}$ |

## 2A, 40V Step-Down DC-DC Converter with Dynamic Output-Voltage Programming

| REVISION <br> NUMBER | REVISION <br> DATE | DESCRIPTION | PAGES <br> CHANGED |
| :---: | :---: | :--- | :---: |
| 0 | $4 / 07$ | Initial release | - |
| 1 | $5 / 11$ | Corrected the feedback resistor reference from R6 to R9 in the Compensation When <br> $f_{C}<f_{E S R}$ section | 14 |

